

Gabellichtschranke Slotted Interrupter

SFH 9500



Wesentliche Merkmale

- Geeignet für Oberflächenmontage (SMT)
- Kompaktes Gehäuse
- GaAs-IR-Sendediode (940 nm)
- Si-Fototransistor mit Tageslichtsperrfilter
- Mit Positionspine
- Geeignet für „pick and place“ Montage
- Hohe Genauigkeit (Schlitzbreite 0,5 mm)
- Große Spaltbreite zwischen Sender und Empfänger (5 mm)
- Hohe Stabilität auf PCB durch große Bauelementabmessung (6,8 mm)

Anwendungen

- Geschwindigkeitsüberwachung
- Motorsteuerung
- Überwachung des Papiervorschubs in Druckern, Kopier- und Faxgeräten
- Speicherlaufwerke
- Steuerung des Druckkopfes in Druckern
- Münzdetektion
- Optoelektronische Schalter

Features

- Suitable for surface mounting (SMT)
- Compact type
- GaAs infrared emitter (940 nm)
- Silicon phototransistor detector with daylight-cutoff filter
- With positioning pin
- Suitable for pick and place
- High sensing accuracy (slit width: 0.5 mm)
- Wide gap between emitter and detector (5 mm)
- High stability on pcb due to large width of device (6.8 mm)

Applications

- Speed control
- Motor control
- Monitoring of paper feed in printers, copiers, facsimiles
- Disk drives
- Control of print head in printers
- Coin detection
- Optoelectronic switches

Typ Type	Bestellnummer Ordering Code	Gehäuse Package
SFH 9500	Q62702-P5066	Schwarzes Polykarbonat Plastikgehäuse, Anschlüsse im 2.54-mm Raster, Senderseite durch Buchstaben „E“, Empfängerseite durch Buchstaben „S“ gekennzeichnet, Kathode / Transistoremitter durch schräge Kante gekennzeichnet Black polycarbonate plastic material housing, solder tabs 2.54-mm (1/10") spacing, emitter side marked with letter "E", sensor side marked with letter "S", cathode / emitter of transistor marked with edge at an angle

Grenzwerte $T_A = 25\text{ °C}$

Maximum Ratings

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
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Sender (GaAs-Diode)

Emitter (GaAs Diode)

Sperrspannung Reverse voltage	V_R	5	V
Durchlaßstrom Forward current	I_F (DC)	60	mA
Verlustleistung Power dissipation	P_{tot}	100	mW
Wärmewiderstand Thermal resistance	R_{thJA}	280	K/W

Grenzwerte $T_A = 25\text{ °C}$
Maximum Ratings (cont'd)

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Empfänger (Si-Fototransistor) Detector (Silicon Phototransistor)			
Kollektor-Emitter-Spannung Collector-emitter voltage	V_{CE}	30	V
Kollektor-Emitter-Spannung, ($t \leq 2\text{ min}$) Collector-emitter voltage	V_{CE}	70	
Emitter-Kollektor-Spannung Emitter-collector voltage	V_{EC}	7	
Kollektorstrom Collector current	I_C	50	mA
Verlustleistung Total power dissipation	P_{tot}	150	mW
Wärmewiderstand Thermal resistance	R_{thJA}	280	K/W

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Lagertemperatur Storage temperature range	T_{stg}	- 40 ... + 85	°C
Betriebstemperatur Operating temperature range	T_{op}	- 40 ... + 85	
Elektrostatische Entladung Electrostatic discharge	ESD	2	kV

Kennwerte $T_A = 25\text{ °C}$ **Characteristics**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Sender (GaAs-Diode) Emitter (GaAs Diode)			
Wellenlänge der Strahlung Wavelength of peak emission	λ_{peak}	940	nm
Durchlaßspannung Forward voltage $I_F = 20\text{ mA}, t_p = 20\text{ ms}$	V_F	1.2 (≤ 1.4)	V
Sperrstrom Reverse current $V_R = 5\text{ V}$	I_R	0.01 (≤ 1)	μA
Kapazität Capacitance $V_R = 0\text{ V}, f = 1\text{ MHz}$	C_0	16	pF

Empfänger (Si-Fototransistor)**Detector (Silicon Phototransistor)**

Wellenlänge der max. Fotoempfindlichkeit Wavelength of max. sensitivity	$\lambda_{S\text{ max}}$	920	nm
Spectr. Bereich der Fotoempfindlichkeit Spectral range of sensitivity $S = 10\%$ of S_{max}	λ	840 ... 1080	nm
Kapazität Capacitance $V_{CE} = 0\text{ V}, f = 1\text{ MHz}, E = 0$	C_{CE}	6.5	pF
Dunkelstrom, $V_{CE} = 20\text{ V}$ Dark current	I_{CEO}	2 (≤ 50)	nA

Kennwerte $T_A = 25\text{ °C}$ (cont'd)

Characteristics

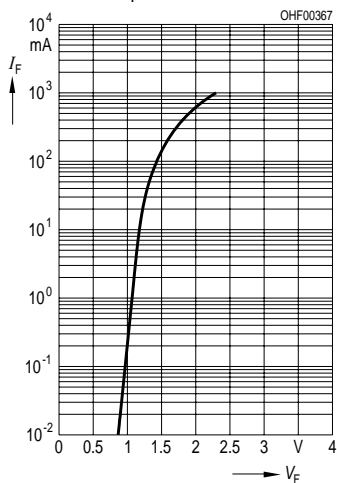
Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
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Gabellichtschranke

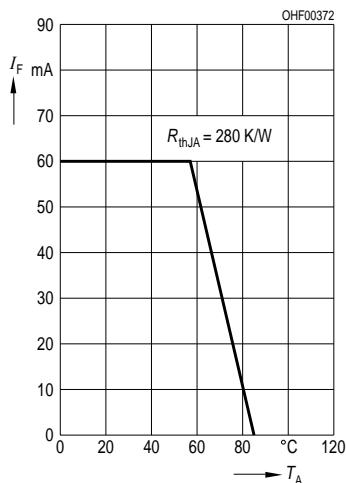
Slotted interrupter

Kollektor-Emitterstrom Collector-emitter current $I_F = 20\text{ mA}; V_{CE} = 5\text{ V}$	I_{CE}	> 1	mA
Kollektor-Emitter-Sättigungsspannung Collector-emitter-saturation voltage $I_F = 20\text{ mA}; I_C = 0.3\text{ mA}$	$V_{CE\text{ sat}}$	≤ 0.4	V
Anstiegs- und Abfallzeit Rise and fall time $V_{CC} = 5\text{ V}, I_C = 1\text{ mA}, R_L = 1\text{ k}\Omega$	t_r t_f	13 17	μs μs

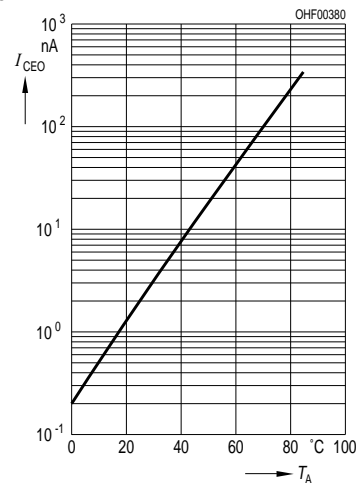
Forward Current $I_F = f(V_F)$
Single pulse, $t_p = 20 \mu s$



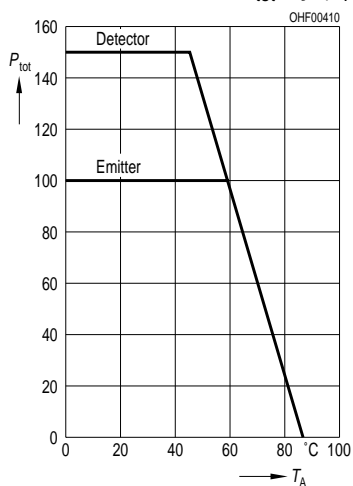
Max. Permissible Forward Current $I_F = f(T_A)$



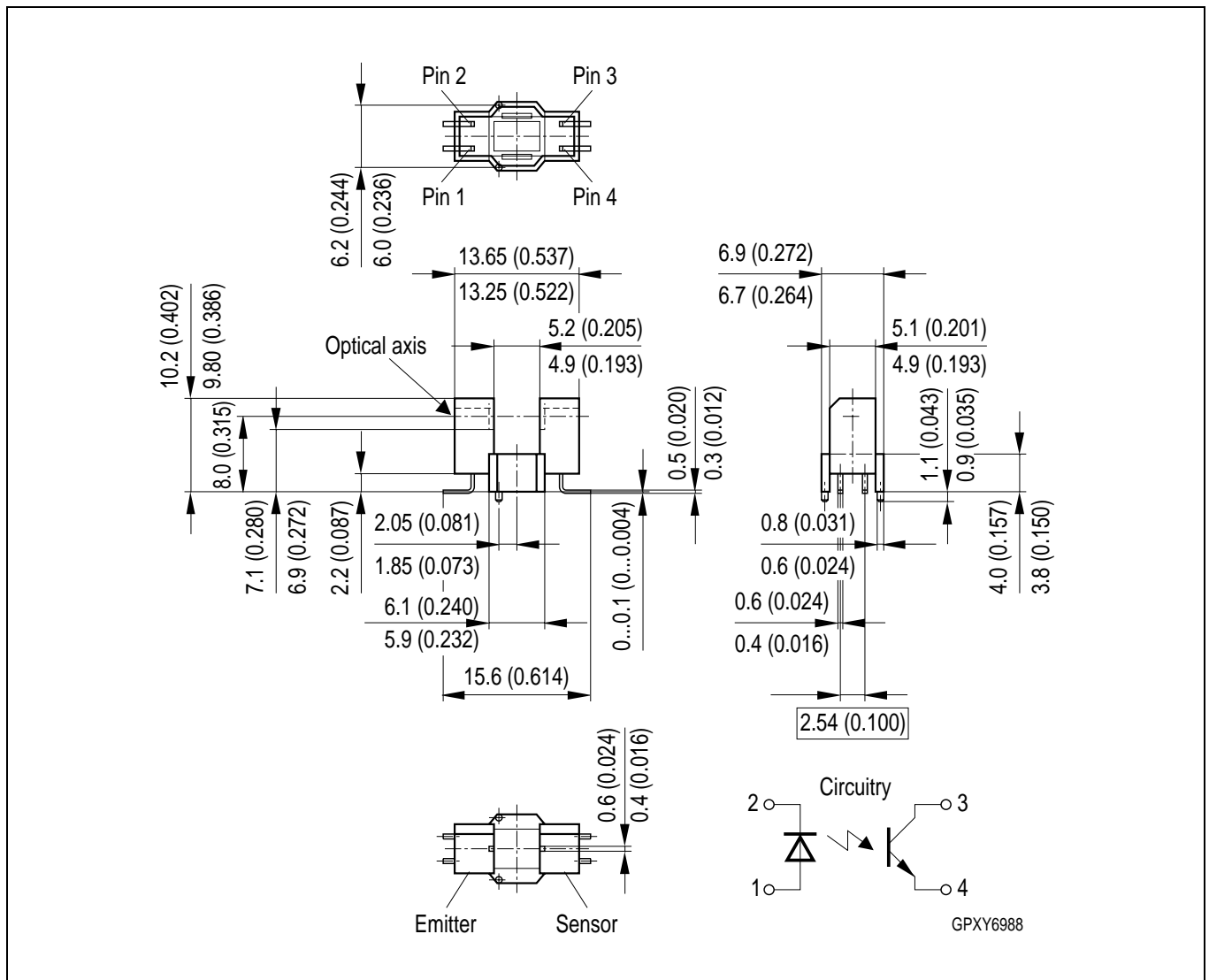
Dark Current $I_{CEO} = f(T_A)$
 $V_{CE} = 20 \text{ V}, E = 0$



Total Power Dissipation for Emitter and Detector $P_{tot} = f(T_A)$



Maßzeichnung
Package Outlines



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

Löthinweise
Soldering Conditions

Bauform Type	Reflowlötung Reflow Soldering		Tauch-, Schwalllötung Dip, Wave Soldering
	Peak Temp. of Soldering Zone	Max. Time in Peak Zone	
SFH 9500	245 °C ... 215 °C Preheating 150 °C	10 s ... 40 s approx. 1 min.	–

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Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

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